



- NOTE:
- MATERIAL SPECIFICATION:
 - HOUSING: LCP, UL94 V-0.
 - CONTACTS: COPPER ALLOY
 - FRONT SHELL: COPPER ALLOY
 - PLATING SPECIFICATION:
 - TERMINAL:
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
 - FRONT SHELL:
Ni 30u" MIN. UNDER PLATED OVER ALL.
 - MECHANICAL PERFORMANCE,
 - INSERTION FORCE: 3.5Kgf MAX
 - REMOVAL FORCE: 1.02kgf MIN
 - DURABILITY: 1500 CYCLES.
 - ELECTRICAL PERFORMANCE,
 - CURRENT RATING:
VBUS & GND PINS: 1.8A MAX.
OTHER PINS: 0.25A MAX.
 - LLCR:
VBUS & GND PINS : 30mΩ/PIN MAX.
ALL OTHER PINS: 50mΩ/PIN MAX.
LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 - INSULATION RESISTANCE: 100MΩ MIN
 - DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.
 - ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -25°C~+85°C.

All materials must meet GREENCONN hazardous substances control standards.

Ordering Information

C UZB605 - 09

XX

A 001

C

X

Z

X

Standard Plating
02=Gold Flash
Selective Plating
05=Gold Flash/Tin

Color
7=Blue

Standard Packing
B=Tray

格菱股份有限公司
Greenconn Corporation

REV. 01 UNIT. mm SCALE. 1:1 PAGE. 1/1

GENERAL TOLERANCE

X.'±5.0'	X.±0.5
.X'±3.0'	.X±0.38
.XX'±2.0'	.XX±0.20
.XXX'±	.XXX±0.10

DESIGNED:

DATE:

DWG. NO.

CUZB605-CA1CZ

TITLE.

Conn USB 3.0BF 90度
DIP

CHECKED:

DATE:

PART NO.

CUZB605-09XXA001CXZX

APPROVED:

DATE: